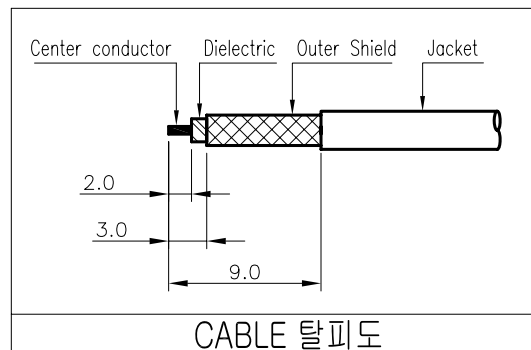
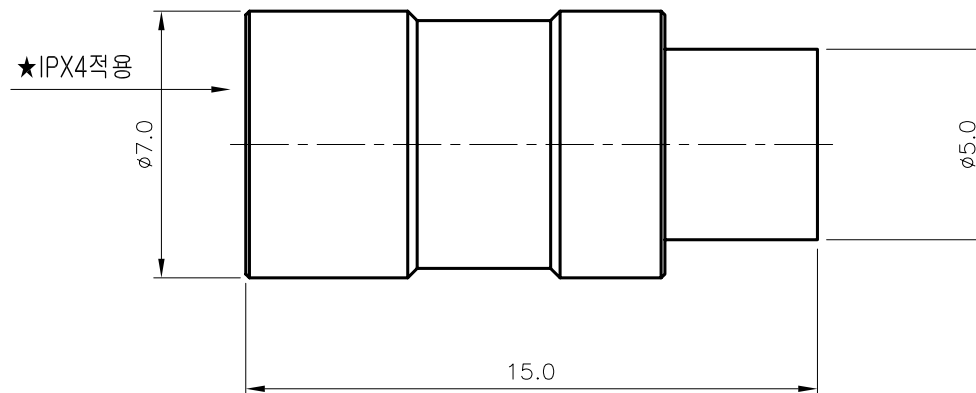


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2018.01.24.
1	[절판No.201807-0005] 메이팅 개선으로 인한 GASKET 경도 변경 (경도60%→40%)	S.Y.EUN	I.C.KIM	2018.07.11.



5	JACK	1	BeCu C17300	Nickel Plate	DJA00159-5/9
4	INSULATOR	1	TEFLON		DIN02969-N/1
3	GASKET	1	SILICONE RUB		DGK00317-N/2 DGK00317-N/2
2	CONTACT	1	BeCu C17300	Gold Plate	DCT03917-5/1
1	BODY	1	MBsBD C3604BD-F	Nickel Plate	DBD04381-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2018. 07. 11.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		TITLE SMBL50 CABLE JS 141FJ(50Ω)
		DRAWN BY	S.Y.EUN	
FINISH		SCALE	5/1	DWG NO. CN03763-7/1
		UNIT	mm	
				REVISION 1
				SHEET 1 of 1